

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Kei-Yu Ko

Docket No.
11675.114

Serial No.
08/846,671

Filing Date
April 30, 1997

Examiner
George A. Gourdeau

Group Art Unit
1765

Invention: UNDOPED SILICON DIOXIDE AS ETCH STOP FOR SELECTIVE ETCH OF DOPED SILICON DIOXIDE

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TC 1700

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	43 -	54 =	0	x \$18.00	\$0.00
INDEP. CLAIMS	7 -	8 =	0	x \$78.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- No additional fee is required for amendment.
- Please charge Deposit Account No. _____ in the amount of _____
A duplicate copy of this sheet is enclosed.
- A check in the amount of _____ to cover the filing fee is enclosed.
- The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 23-3178
A duplicate copy of this sheet is enclosed.
 - Any additional filing fees required under 37 C.F.R. 1.16.
 - Any patent application processing fees under 37 CFR 1.17.


Signature

Dated: November 30, 2000

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PATENT TRADEMARK OFFICE

CC:

I certify that this document and fee is being deposited on _____ with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

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PATENT APPLICATION

Docket No. 11675.114

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Kei-Yu Ko

Serial No.: 08/846.671

Filed: April 30, 1997

For: UNDOPED SILICON DIOXIDE AS
ETCH STOP FOR SELECTIVE ETCH OF
DOPED SILICON DIOXIDE

Examiner: George A. Goudreau

#4 C
12/8/02
M

AMENDMENT C UNDER 37 C.F.R. § 1.111

The Honorable Commissioner of Patents
and Trademarks
Washington, D. C. 20231

Sir:

In response to the Office Action mailed on August 30, 2000 (the "Office Action"), the Applicants submit this Amendment C and response.

IN THE CLAIMS

Cancel Claims 11, 15, 21-23, 39, 45, and 53.

CLEAN VERSION OF THE PENDING CLAIMS Under 37 C.F.R. § 1.121(c)(3):

Claims 1-10, 12-14, 16-20, 24-38, 40-44, 46, 50-52, and 54, now pending, are submitted below in accordance with 37 C.F.R. § 1.121(c)(3), which presents a clean version of the entire set of pending claims in this single amendment paper.